



Banking & ID solutions



Smartcards market applications A strong expertise in Smartcard Industry

Banking



- Banking cards
- Biometry
- dCVV
- Wearables

Identity



- (National) eID
- ePassport
- eSignature
- eDriving License
- eHealthcare
- eTachograph

Transport



Calypso®

PayTV





A full range of banking solutions

Contact, dual Interface ICs and system-on-chip solutions



ST31 Secure MCU

- Dual core 32-bit ARM SC000 CPU
- Multiprotocol (ISO7816, ISO14443 A/B, ISO18092, VHBR)
- EMVCo® & Common Criteria-certified

STPay ST Secure Payment solution

- Ready-to-use proven banking offer
- Multiple International & Domestic Payment schemes supported
- Contact and dual IF offers
- Widely used by > 40 customers worldwide
- Advanced EMV portfolio for innovative cards: BSOC / dCVV

STPay

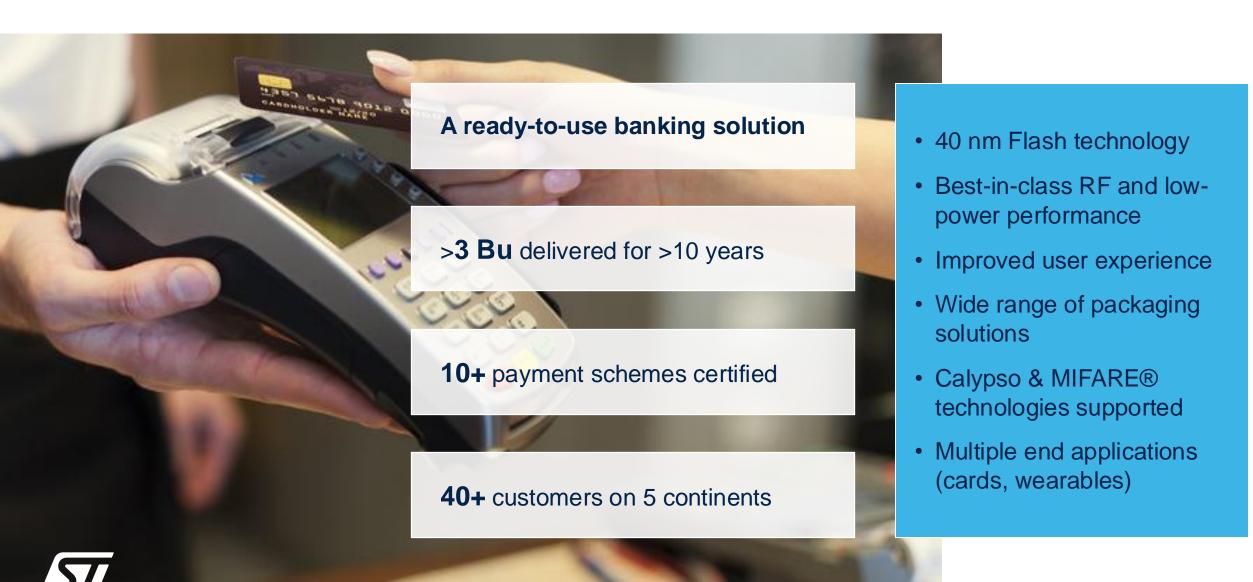
Inlays







STPay ST Secure payment solution



STeID Secure identity solutions



Open Java Card™ solution for single and multi-applications identity cards





Native solutions developed in cooperation with **Masktech GmbH (Germany)**





Based on ST31 Secure Hardware Microcontroller

High performance dual core 32-bit ARM SC000 + Dedicated cryptographic engines

Common Criteria Certified Common Criteria



Data retention >25 years, Erase/Write cycling > 500K cycles

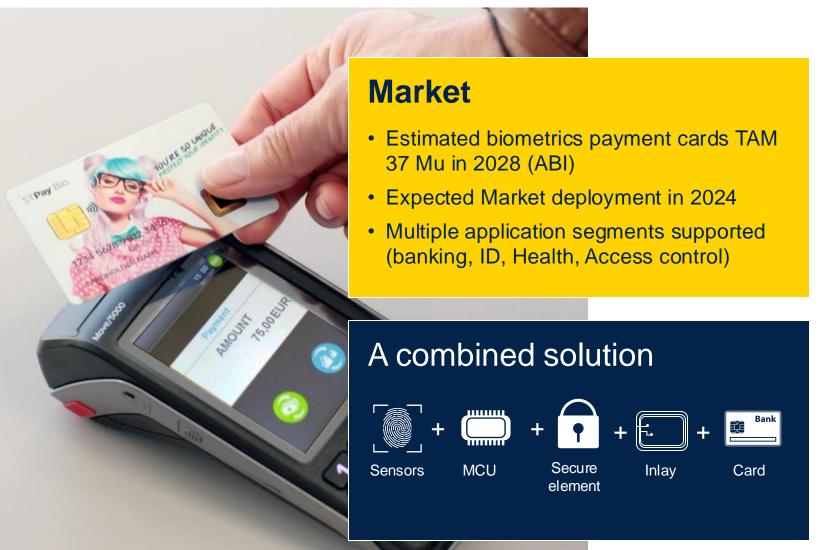


STeID Secure identity solutions

Application Targets



Biometric system-on-card (BSoC)



Solution

- Enhanced secure & easy to use
- Unicity granted (Not transferable, Not duplicable)
- Suitable for PIN-less operations
 Toll gate, health cards, contactless transactions
- Usable in conjunction with PIN code
- Easy to use
 Multiplatform technology,
 nothing to remember



Biometric system-on-card: key challenges

New technology, better performance, state-of-the-art product



Market maturity

- User acceptance
- Card cost



System interoperability & security

- Components isolation
- · Agnosticism vs. technology choices



Technical requirements

- Transaction performances
- Power management (without battery or super capacity when RF)
- Standardization



Card lifecycle

 Strongly depends on daily transactions amount (unpredictable) and power management type



Card manufacturing

- Size and thickness (ISO 0.76 mm)
- Flexibility (ISO / CQM compliancy for resistance to mechanical stresses)
- Lamination

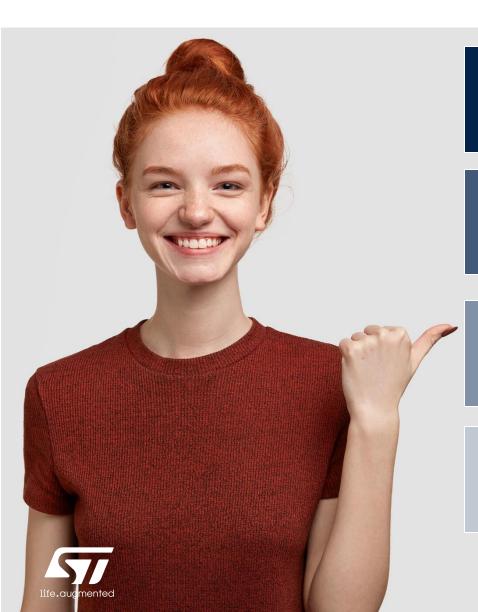


Performance

 From Capture to Verification / enrollment in 1 sec (Match-on card)



Secure smartcard takeaways



Based on ST31, using an innovative 40 nm Flash technology

STPay, a complete and proven worldwide secure payment solution

ST biometric system-on-card solutions, the leading edge of technology

STeID, trusted identity for everyone

Our technology starts with You



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